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APPLICATION NO.		FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/539,926		06/14/2005	Sadamu Ishidu	20239/0202616-US0	8405
7278	7590	04/06/2006		EXAMINER	
DARBY & DARBY P.C.			CRANE, SARA W		
P. O. BOX 5257 NEW YORK, NY 10150-5257				ART UNIT	PAPER NUMBER
1.2 1014	-,			2811	
		,		DATE MAILED: 04/06/2006	5

Please find below and/or attached an Office communication concerning this application or proceeding.

<u> </u>		<u> </u>	<u> </u>
	Application No.	Applicant(s)	•
	10/539,926	ISHIDU ET AL.	
Office Action Summary	Examiner	Art Unit	
	Sara W. Crane	2811	
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet w	ith the correspondence address	
A SHORTENED STATUTORY PERIOD FOR REF WHICHEVER IS LONGER, FROM THE MAILING - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory peri - Failure to reply within the set or extended period for reply will, by sta Any reply received by the Office later than three months after the ma earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUN 1:136(a). In no event, however, may a od will apply and will expire SIX (6) MO tute, cause the application to become A	CATION. reply be timely filed NTHS from the mailing date of this communication. BANDONED (35 U.S.C. § 133).	*
Status			
Responsive to communication(s) filed on 2a) ☐ This action is FINAL.	his action is non-final. vance except for formal ma	•	
Disposition of Claims			
4) ⊠ Claim(s) <u>1-3</u> is/are pending in the application 4a) Of the above claim(s) is/are withd 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) <u>1-3</u> is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and	rawn from consideration.		
Application Papers			
9) The specification is objected to by the Examination The drawing(s) filed on is/are: a) and a an applicant may not request that any objection to the Replacement drawing sheet(s) including the correction of the correction	ccepted or b) objected to he drawing(s) be held in abeya ection is required if the drawing	nce. See 37 CFR 1.85(a). g(s) is objected to. See 37 CFR 1.121(d).	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for forei a) All b) Some * c) None of: 1. Certified copies of the priority docume 2. Certified copies of the priority docume 3. Copies of the certified copies of the priority docume application from the International Bure * See the attached detailed Office action for a li	ents have been received. ents have been received in a riority documents have been eau (PCT Rule 17.2(a)).	Application No received in this National Stage	
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/0 Paper No(s)/Mail Date	Paper No	Summary (PTO-413) (s)/Mail Date Informal Patent Application (PTO-152) 	

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DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-3 are rejected under 35 U.S.C. 103(a) as being unpatentable over Japan 11-026647 in view of Tamaoki et al. and Yamamoto et al.

With respect to claim 1, the Japanese reference 11-026647 shows a light emitting semiconductor element 34, mounted on a substrate 1 (see figure 1). The distance corresponding to H would be the distance from the top of the substrate (where the semiconductor is mounted) to the bottom of the substrate. It is clear from figure 1 that this distance is two or three times either length dimension of the semiconductor element, certainly much greater than 0.3 times the length dimension of the semiconductor element. Tamaoki et al. teaches that a typical light emitting area of a LED is around 1 mm² (column 2, lines 26-30). This area is commensurate with the chip area itself, as shown in for example figure 1, where the light emitting area is identified as the upper area of the chip. It would have been obvious to make the light emitting device of the Japan 11-026647 reference of the same area as taught by Tamaoki et al, because the Tamaoki reference is describing typical prior art LEDs. Yamamoto et al. teaches sintered aluminum nitride as a substrate material for light-emitting diode devices

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(column 16, lines 9-14). As taught in the abstract of this reference, this material has thermal conductivity greater than that required by claim 1. It would have been obvious to use the Yamamoto et al. material as substrate material for the device of the Japan 11-026647 reference, to obtain the desirable properties of such a substrate as taught by Yamamoto et al. Note that the Yamamoto substrate is 1.5 mm thick (column 23, line 19), which is also a good deal larger than 0.3 times the 1mm chip length of the Tamaoki light emitting chip. The substrate and chip dimensions of the prior art devices of Tamaoki et al. and Yamamoto et al. are thus comparable to those shown in the figure of the Japan 11-026647 reference.

With respect to claim 2, the chip of the Japan reference is in a cavity, and the upper electrode is on the top surface. Metal for the upper electrode would have been obvious because this is the usual electrode material, used for its high conductivity. With respect to claim 3, the device of the Japanese reference has a terminal plate (2b at the bottom of the substrate) that supplies power to the light emitting element through a connection member formed of a vertical conductor (on the sidewall of the substrate) and a horizontal conductor (on the top of the substrate), which is spaced apart from the cavity.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to S. Crane, whose telephone number is (571) 272-1652.

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The supervisor for Art Unit 2811, Eddie Lee can be reached on (571) 272-1732. The fax phone number for the organization where this application or proceeding is assigned is (571) 273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Sara W. Crane
Primary Examiner
Art Unit 2811